TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC7MH153FK

Dual 4-Channel Multiplexer

The TC7MH153FK is an advanced high speed CMOS dual 4-channel multiplexers fabricated with silicon gate C²MOS technology.

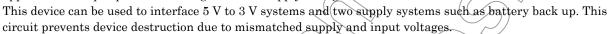
It achieves the high speed operation similar to equivalent bipolar schottky TTL while maintaining the CMOS low power dissipation.

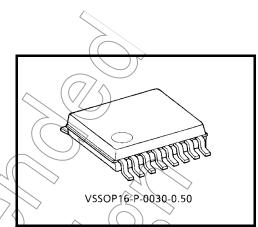
Each of these data (1C0-1C3, 2C0-2C3) is selected by the two address inputs A and B.

Separate strobe inputs $(1\overline{G}, 2\overline{G})$ are provided for each of the two four-line sections.

The strobe input (G) can be used to inhibit the data output; the output is fixed in low level while the strobe input is held high.

An input protection circuit ensures that 0 to 5.5 V can be applied to the input pins without regard to the supply voltage.

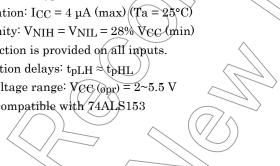




Weight: 0.02 g (typ.)

Features

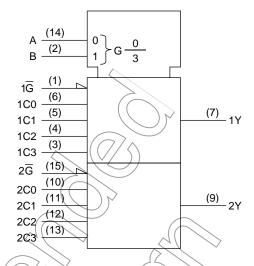
- High speed: $t_{pd} = 5.0 \text{ ns (typ.)} (V_{CC} = 5 \text{ V})$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)} (T_a = 25 ^{\circ}C)$
- High noise immunity: V_{NIH} = V_{NIL} = 28% V_{CC} (min)
- Power down protection is provided on all inputs.
- Balanced propagation delays: tpLH \(\approx\)tpHL\
- Wide operating voltage range: $V_{QC}(\phi_{pr}) = 2 \sim 5.5 \text{ V}$
- Pin and function compatible with 74ALS153



Pin Assignment (top view)

1G 16 V_{CC} В $2\overline{\mathsf{G}}$ 15 1C3 Α 1C2 2C3 1C1 2C2 1C0 2C1 6 1Y 2C0 GND 8 2Y

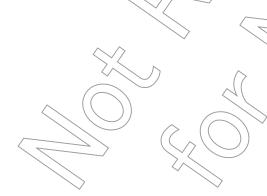
IEC Logic Symbol



Truth Table

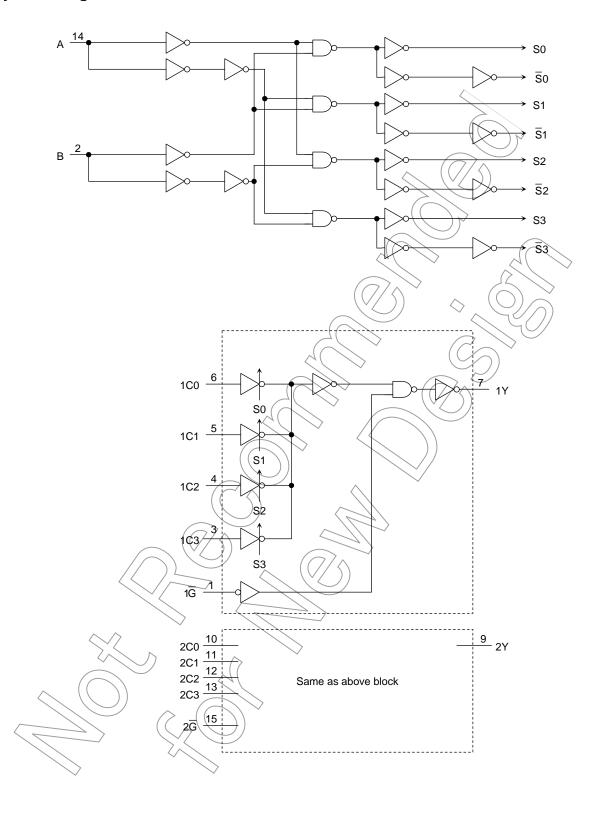
Select Inputs			Data	Inputs		Strobe	Output	
В	Α	C0	C1	C2	С3	G	Y\((
Х	Х	Х	Х	Х	Х	Н	t	
L	L	L	Х	Х	Х	L	C/L	
L	L	Н	Х	Х	Х	L 〈	(H)	
L	Н	Х	L	Х	Х	L () b	
L	Н	Х	Н	Х	Х	L(()) H	
Н	L	Х	Х	L	Х	(1)	L	
Н	L	Х	Х	Н	Х	((L))	Н	
Н	Н	Х	Х	Х	4		L	
Н	Н	Χ	Χ	X	ĺ ⊬(∧	<u>/ </u>	H	





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System Diagram



Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit	
Supply voltage range	V _{CC}	-0.5~7.0	V	
DC input voltage	VIN	-0.5~7.0	V	
DC output voltage	Vout	-0.5~V _{CC} + 0.5	V	
Input diode current	l _{IK}	-20	mA <	
Output diode current	lok	±20	mA	
DC output current	lout	±25	mA	
DC V _{CC} /ground current	Icc	±50	mA	
Power dissipation	PD	180	mW(/	
Storage temperature	T _{stg}	-65~150	\%C\\\	

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	2.0~5.5	$(\sqrt{V})/\langle$
Input voltage	V _{IN}	0~5.5	
Output voltage	Vout	0~V _{CC}	\\v
Operating temperature	T _{opr}	-40~85) ° C
Input rise and fall time	dt/dv	$0-100 \text{ (V}_{CC} = 3.3 \pm 0.3 \text{ V)}$ $0-20 \text{ (V}_{CC} = 5 \pm 0.5 \text{ V)}$	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

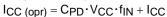
Characteristics		Symbol Test Condition			Ta = 25°C			Ta = -40~85°C		Unit	
				Condition	V _{CC} (V)	Min	Тур.	Max	Min	Max	Unit
	$\wedge \wedge$				2.0	1.50	_	_	1.50	_	V
lament valtages	High level	V _{IH}			3.0~5.5	V _{CC} × 0.7	_	_	V _{CC} × 0.7		
Input voltage			V _{IL}		2.0	1	1	0.50	_	0.50	
	Low level	V _{IL}			3.0~5.5			V _{CC} × 0.3	_	V _{CC} × 0.3	
	> (V _{IN} = V _{IH} or V _{IL}	I _{OH} = -50 μA	2.0	1.9	2.0	1	1.9		
	High level	V _{ОН}			3.0	2.9	3.0		2.9		
					4.5	4.4	4.5	1	4.4		
				$I_{OH} = -4 \text{ mA}$	3.0	2.58		-	2.48	_	
Output voltage				$I_{OH} = -8 \text{ mA}$	4.5	3.94		-	3.80	_	
Output voltage	Low level	V _{OL}	V _{IN} = V _{IH} or V _{IL}	I _{OL} = 50 μA	2.0	1	0	0.1	_	0.1	
					3.0		0	0.1	—	0.1	
					4.5	1	0	0.1		0.1	
				$I_{OL} = 4 \text{ mA}$	3.0	1	1	0.36	_	0.44	
				$I_{OL} = 8 \text{ mA}$	4.5	1	1	0.36		0.44	
Input leakage current		I _{IN}	V _{IN} = 5.5 V or GND		0~5.5		1	±0.1	_	±1.0	μА
Quiescent supply current		Icc	V _{IN} = V _{CC} or GND		5.5	_	_	4.0	_	40.0	μΑ

AC Characteristics (Input: $t_r = t_f = 3 \text{ ns}$)

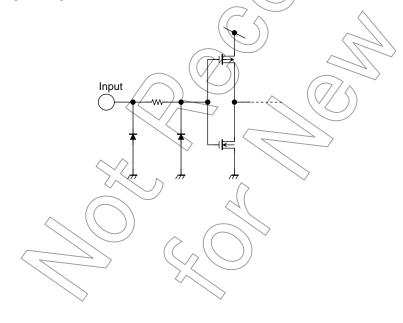
Characteristics	Symbol	Toot Condition			Ta = 25°C)	Ta = -40~85°C		Unit
Characteristics	Symbol	Test Condition	V _{CC} (V)	C _L (pF)	Min	Тур.	Max	Min	Max	Unit
		_	3.3 ± 0.3	15	_	7.7	11.9	1.0	14.0	- ns
Propagation delay time	t _{pLH}			50	_	10.2	15.4	1.0	17.5	
(C _n -Y)	tpHL		5.0 ± 0.5	15	_	5.0	7.7	1.0	9.0	
			3.0 ± 0.3	50	_	6.5	9.7	1.0	11.0	
		_	3.3 ± 0.3	15	—	10.8	16.7	1.0	19.5	ns
Propagation delay time	^t pLH ^t pHL			50	~	13.3	20.2	1.0	23.0	
(A, B-Y)			5.0 ± 0.5	15		6.8	9.9	1.0	11.5	
				50	-((8.3	11.9	1.0	13.5	
		LH HL —	3.3 ± 0.3	15		6.3	10.1	1.0	12.0	
Propagation delay time	t _{pLH}			50 <	1(-/	8.8	13.6	1.0	15.5	
(G -Y)	t _{pHL}		5.0 ± 0.5	15		4.4	6.4	1.0	7.5	
				50//	\(\frac{1}{2}\)	5.9	8.4	1.0	9.5	
Input capacitance	C _{IN}	-	_ (4	(10)	(4)	/ 10	pF
Power dissipation capacitance	C _{PD}			(Note)	_	20	7	> _	_	pF

Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

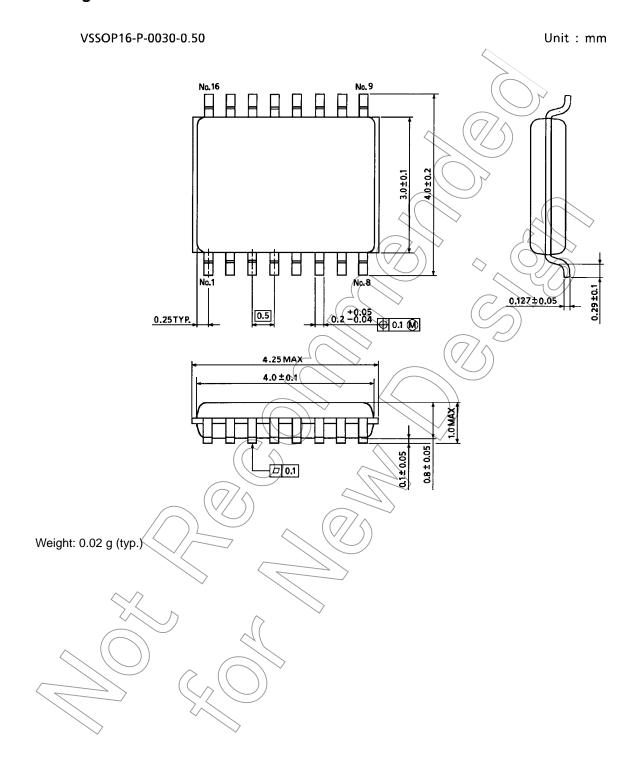
Average operating current can be obtained by the equation:



Input Equivalent Circuit



Package Dimensions



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